

Part Number

5

7

Lead

0

2

Plating

Pin Style

Positions Per Row

Options

1 = Through Hole (TH)
2 = Surface Mount (SMT)

F = Flash Gold on contact area, 150 µ" Tin-Lead on tail
S = 15 µ" Gold on contact area, 150 µ" Tin-Lead on tail
G = 30 µ" Gold on contact area, 150 µ" Tin-Lead on tail

02 to 25 (TH)
02 to 25 (SMT)

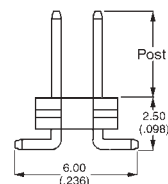
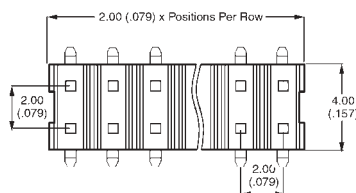
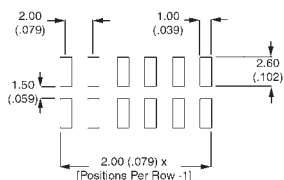
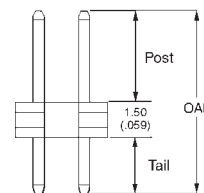
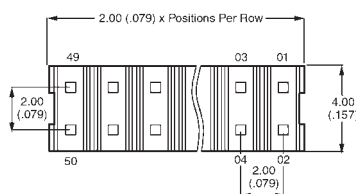
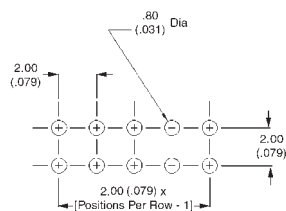
01... 50 = Polarization
Specify position number (i.e., 01) to omit pin

R = Retentive Leg (TH) or polarized designation

Optional SMT packaging:
U = Tubes without pickup caps
A = Tape-and-reel packaging with pick up caps
- = Packaged in bags (dash not needed if no other options are selected)

Pin Style	Surface Mount	
	mm	(in.)
51	2.00	(.079)
52	4.00	(.157)

Pin Style	Through Hole					
	Post		Tail		OAL	
	mm	(in.)	mm	(in.)	mm	(in.)
02	2.00	(.079)	2.50	(.098)	6.00	(.236)
04	2.00	(.079)	3.00	(.118)	6.50	(.256)
06	4.00	(.157)	2.50	(.098)	8.00	(.315)
08	4.00	(.157)	3.00	(.118)	8.50	(.335)



Recommended PCB Layout

